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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Active
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	402
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-5fn672i

By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

Figure 2-29. Input Register Block for Left, Right and Bottom Edges

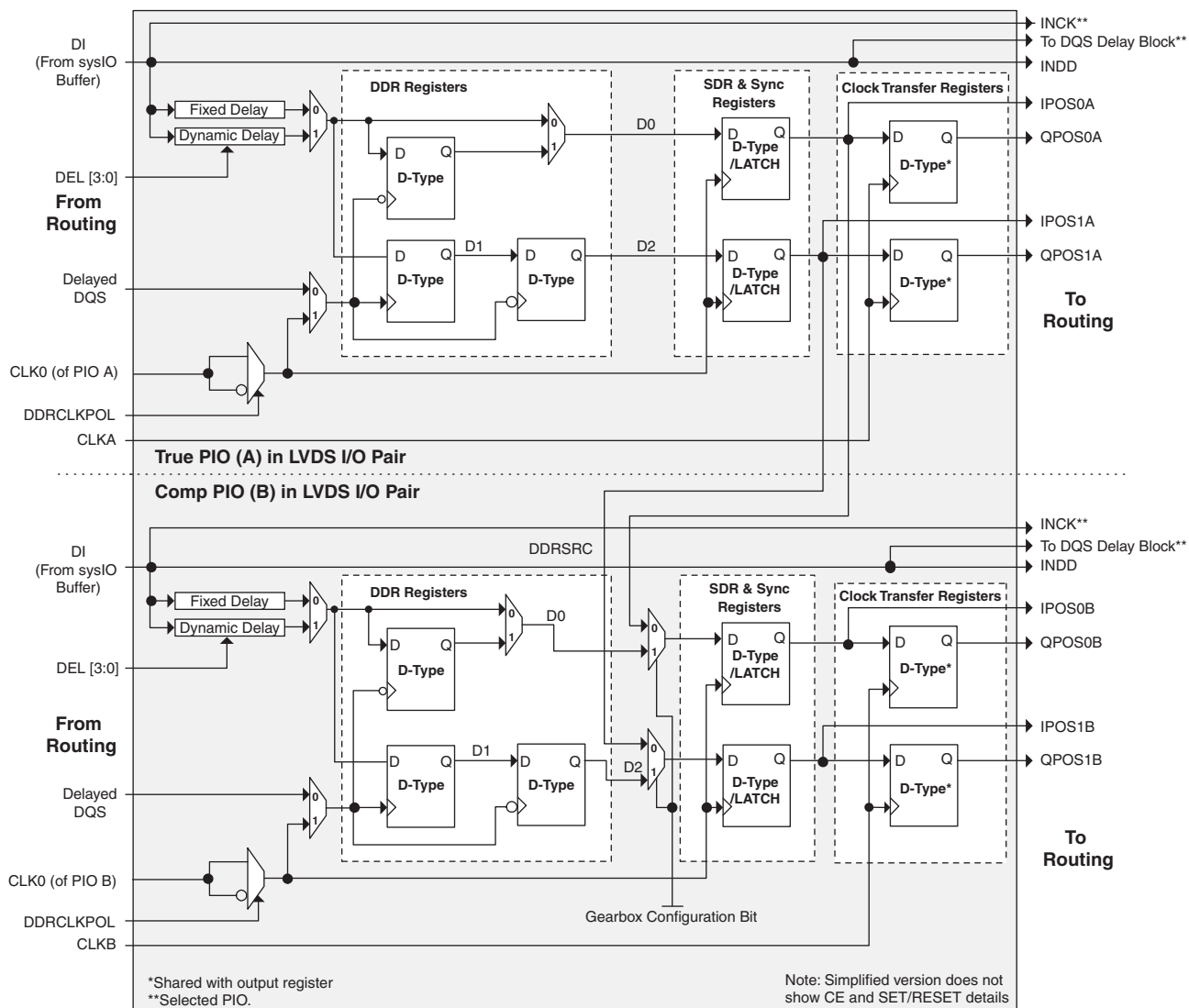
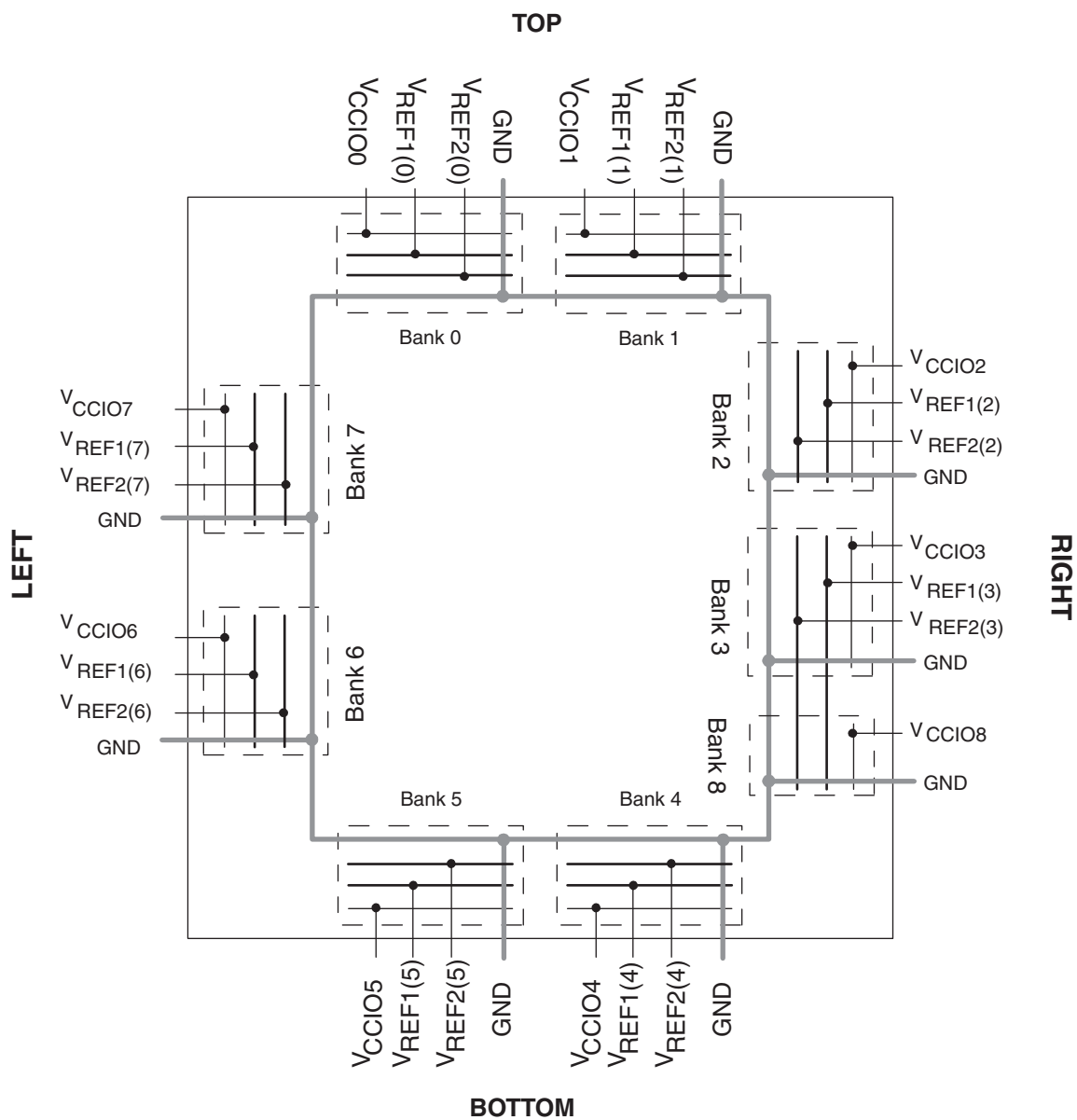


Figure 2-37. LatticeECP2 Banks



Symbol	Parameter	Min.	Max.	Units
V_{CCP}^6	PLL and Reference Clock Buffer Power	1.14	1.26	V

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} . V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/ μ s during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC} , V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8} , the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of V_{CC} or V_{CCAUX} reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M "S" version devices only).
6. V_{CCRX} , V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 [Electrical Recommendations for Lattice SERDES](#).

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O leakage current	$0 \leq V_{IN} \leq V_{IH} \text{ (MAX.)}$	—	—	+/-1000	μ A
I_{HDIN}^5	SERDES average input current when device is powered down and inputs are driven		—	—	4	mA

1. V_{CC} , V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \leq V_{CC} \leq V_{CC} \text{ (MAX.)}$, $0 \leq V_{CCIO} \leq V_{CCIO} \text{ (MAX.)}$ or $0 \leq V_{CCAUX} \leq V_{CCAUX} \text{ (MAX.)}$.
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to [LatticeECP2/M Product Family Qualification Summary](#) for complete qualification data, including ESD performance.

LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)
Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
LVC MOS25_4mA	LVC MOS 2.5 4mA drive, slow slew rate	2.18	2.26	2.33	ns
LVC MOS25_8mA	LVC MOS 2.5 8mA drive, slow slew rate	2.19	2.35	2.51	ns
LVC MOS25_12mA	LVC MOS 2.5 12mA drive, slow slew rate	1.50	1.66	1.82	ns
LVC MOS25_16mA	LVC MOS 2.5 16mA drive, slow slew rate	1.60	1.59	1.58	ns
LVC MOS25_20mA	LVC MOS 2.5 20mA drive, slow slew rate	1.43	1.39	1.34	ns
LVC MOS18_4mA	LVC MOS 1.8 4mA drive, slow slew rate	2.22	2.27	2.32	ns
LVC MOS18_8mA	LVC MOS 1.8 8mA drive, slow slew rate	1.93	2.08	2.23	ns
LVC MOS18_12mA	LVC MOS 1.8 12mA drive, slow slew rate	1.43	1.51	1.58	ns
LVC MOS18_16mA	LVC MOS 1.8 16mA drive, slow slew rate	1.47	1.46	1.45	ns
LVC MOS15_4mA	LVC MOS 1.5 4mA drive, slow slew rate	2.32	2.38	2.43	ns
LVC MOS15_8mA	LVC MOS 1.5 8mA drive, slow slew rate	1.84	1.98	2.12	ns
LVC MOS12_2mA	LVC MOS 1.2 2mA drive, slow slew rate	2.52	2.63	2.74	ns
LVC MOS12_6mA	LVC MOS 1.2 6mA drive, slow slew rate	1.69	1.83	1.96	ns
PCI33	PCI33	0.04	0.04	0.04	ns

1. Timing Adders are characterized but not tested on every device.
 2. LVC MOS timing measured with the load specified in Switching Test Condition table.
 3. All other standards tested according to the appropriate specifications.
 4. These timing adders are measured with the recommended resistor values.
- Timing v.A 0.11

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See “Typical sysI/O I/O Behavior During Power-up” for more information about I/O behavior during power-up.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers.
V _{CCIOx}	—	Dedicated power supply pins for I/O bank x.
V _{CCPLL}	—	PLL supply pins. Should be tied to V _{CC} even when the corresponding PLL is unused.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES ⁴	—	10K ohm +/-1% resistor must be connected between this pad and ground.
PLLCAP ⁴	—	External capacitor connection for PLL.
PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_V _{CCPLL}	—	Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center.
[LOC][num]_GPLL[T, C]_IN_A	I	General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_GPLL[T, C]_FB_A	I	Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_IN_A ⁵	I	Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_FB_A ⁵	I	Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_IN_A	I	DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_FB_A	I	Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		140	304	140	303	410
Differential Pair User I/O		70	152	70	151	199
Configuration	TAP Pins	5	5	5	5	5
	Muxed Pins	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7
Non Configuration	Muxed Pins	64	84	60	84	89
	Dedicated Pins	3	3	3	3	3
VCC		6	16	6	16	29
VCCAUX		4	8	4	8	17
VCCPLL		1	4	1	4	8
VCCIO	Bank0	1	4	1	4	5
	Bank1	1	3	1	3	4
	Bank2	2	4	2	4	5
	Bank3	2	4	2	4	5
	Bank4	2	4	2	4	4
	Bank5	2	4	2	4	5
	Bank6	2	4	2	4	5
	Bank7	2	4	2	4	5
	Bank8	1	2	1	2	2
GND, GND0 to GND7		22	57	22	57	80
NC		17	11	17	12	37
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	0/0	36/18	0/0	36/18	63/31
	Bank1	0/0	18/9	0/0	18/9	18/9
	Bank2	14/7	30/15	14/7	30/15	50/25
	Bank3	16/8	36/18	16/8	36/18	43/21
	Bank4	32/16	62/31	32/16	62/31	50/21
	Bank5	20/10	28/14	20/10	28/14	60/30
	Bank6	16/8	40/20	16/8	39/19	52/25
	Bank7	28/14	40/20	28/14	40/20	60/30
	Bank8	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0
	Bank2 (Right Edge)	3	7	3	7	12
	Bank3 (Right Edge)	4	9	4	9	11
	Bank4 (Bottom Edge)	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0
	Bank6 (Left Edge)	4	10	4	10	14
	Bank7 (Left Edge)	7	10	7	10	15
	Bank8 (Right Edge)	0	0	0	0	0

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
-	-	-			GNDIO1	1		
-	-	-			VCCIO	1		
D10	PT19B	1		C	PT37B	1		C
C10	PT19A	1		T	PT37A	1		T
GND	GNDIO1	-			GNDIO1	-		
B10	PT18B	1		C	PT36B	1		C
A9	PT17B	1		C	PT35B	1		C
A10	PT18A	1		T	PT36A	1		T
B9	PT17A	1		T	PT35A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A8	PT16B	1		C	PT34B	1		C
D9	PT15B	1		C	PT33B	1		C
B8	PT16A	1		T	PT34A	1		T
C9	PT15A	1		T	PT33A	1		T
GND	GNDIO1	-			GNDIO1	-		
B7	PT14B	1		C	PT32B	1		C
E9	PT13B	1		C	PT31B	1		C
A7	PT14A	1		T	PT32A	1		T
D8	PT13A	1		T	PT31A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A6	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C
B6	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T
E6	XRES	-			XRES	1		
F8	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
E8	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T
A5	PT9B	0		C	PT27B	0		C
A3	PT8B	0		C	PT26B	0		C
A4	PT9A	0		T	PT27A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
B3	PT8A	0		T	PT26A	0		T
A2	PT7B	0		C	PT25B	0		C
C7	PT6B	0		C	PT24B	0		C
B2	PT7A	0		T	PT25A	0		T
D7	PT6A	0		T	PT24A	0		T
D6	PT5B	0		C	PT23B	0		C
GND	GNDIO0	-			GNDIO0	-		
F7	PT4B	0		C	PT22B	0		C
C6	PT5A	0		T	PT23A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F6	PT4A	0		T	PT22A	0		T
C4	PT3B	0		C	PT21B	0		C
B4	PT3A	0		T	PT21A	0		T
-	-	-			GNDIO0	0		
-	-	-			VCCIO	0		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H16	NC	-			NC	-		
H20	NC	-			NC	-		
H18	NC	-			NC	-		
K6	NC	-			NC	-		
J16	NC	-			NC	-		
N18	VCC	-			VCC	-		
N6	VCC	-			VCC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT45B	1		C	PT45B	1		C
A15	PT45A	1		T	PT45A	1		T
A13	PT44B	1		C	PT44B	1		C
B13	PT44A	1		T	PT44A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT43B	1		C	PT43B	1		C
H15	PT43A	1		T	PT43A	1		T
D13	PT42B	1		C	PT42B	1		C
C14	PT42A	1		T	PT42A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT41B	1		C	PT41B	1		C
E14	PT41A	1		T	PT41A	1		T
A12	PT40B	1		C	PT40B	1		C
B12	PT40A	1		T	PT40A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT39B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
D14	PT39A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT37B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT37A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
A11	PT36B	0		C	PT36B	0		C
B11	PT36A	0		T	PT36A	0		T
C13	PT35B	0		C	PT35B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT35A	0		T	PT35A	0		T
D12	PT34B	0		C	PT34B	0		C
F13	PT34A	0		T	PT34A	0		T
A10	PT33B	0		C	PT33B	0		C
B10	PT33A	0		T	PT33A	0		T
C12	PT32B	0		C	PT32B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT32A	0		T	PT32A	0		T
G13	PT31B	0		C	PT31B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT31A	0		T	PT31A	0		T
A9	PT30B	0		C	PT30B	0		C
B9	PT30A	0		T	PT30A	0		T
E12	PT29B	0		C	PT29B	0		C
G12	PT29A	0		T	PT29A	0		T
A8	PT28B	0		C	PT28B	0		C
B8	PT28A	0		T	PT28A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT27B	0		C	PT27B	0		C
C9	PT27A	0		T	PT27A	0		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT54B	1		C	PT63B	1		C
A15	PT54A	1		T	PT63A	1		T
A13	PT53B	1		C	PT62B	1		C
B13	PT53A	1		T	PT62A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT52B	1		C	PT61B	1		C
H15	PT52A	1		T	PT61A	1		T
D13	PT51B	1		C	PT60B	1		C
C14	PT51A	1		T	PT60A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT50B	1		C	PT59B	1		C
E14	PT50A	1		T	PT59A	1		T
A12	PT49B	1		C	PT58B	1		C
B12	PT49A	1		T	PT58A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT48B	1	PCLKC1_0	C	PT57B	1	PCLKC1_0	C
D14	PT48A	1	PCLKT1_0	T	PT57A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0	T
A11	PT45B	0		C	PT54B	0		C
B11	PT45A	0		T	PT54A	0		T
C13	PT44B	0		C	PT53B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT44A	0		T	PT53A	0		T
D12	PT43B	0		C	PT52B	0		C
F13	PT43A	0		T	PT52A	0		T
A10	PT42B	0		C	PT51B	0		C
B10	PT42A	0		T	PT51A	0		T
C12	PT41B	0		C	PT50B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT41A	0		T	PT50A	0		T
G13	PT40B	0		C	PT49B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT40A	0		T	PT49A	0		T
A9	PT39B	0		C	PT48B	0		C
B9	PT39A	0		T	PT48A	0		T
E12	PT38B	0		C	PT47B	0		C
G12	PT38A	0		T	PT47A	0		T
A8	PT37B	0		C	PT46B	0		C
B8	PT37A	0		T	PT46A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT36B	0		C	PT45B	0		C
C9	PT36A	0		T	PT45A	0		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L13	VCC	-			VCC	-			
L18	VCC	-			VCC	-			
L19	VCC	-			VCC	-			
M11	VCC	-			VCC	-			
M12	VCC	-			VCC	-			
M13	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M15	VCC	-			VCC	-			
M16	VCC	-			VCC	-			
M17	VCC	-			VCC	-			
M18	VCC	-			VCC	-			
M19	VCC	-			VCC	-			
M20	VCC	-			VCC	-			
N11	VCC	-			VCC	-			
N12	VCC	-			VCC	-			
N19	VCC	-			VCC	-			
N20	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P19	VCC	-			VCC	-			
R12	VCC	-			VCC	-			
R19	VCC	-			VCC	-			
T12	VCC	-			VCC	-			
T19	VCC	-			VCC	-			
U12	VCC	-			VCC	-			
U19	VCC	-			VCC	-			
V11	VCC	-			VCC	-			
V12	VCC	-			VCC	-			
V19	VCC	-			VCC	-			
V20	VCC	-			VCC	-			
W11	VCC	-			VCC	-			
W12	VCC	-			VCC	-			
W13	VCC	-			VCC	-			
W14	VCC	-			VCC	-			
W15	VCC	-			VCC	-			
W16	VCC	-			VCC	-			
W17	VCC	-			VCC	-			
W18	VCC	-			VCC	-			
W19	VCC	-			VCC	-			
W20	VCC	-			VCC	-			
Y12	VCC	-			VCC	-			
Y13	VCC	-			VCC	-			
Y18	VCC	-			VCC	-			
Y19	VCC	-			VCC	-			
D14	VCCIO0	0			VCCIO0	0			
E6	VCCIO0	0			VCCIO0	0			
E9	VCCIO0	0			VCCIO0	0			
F12	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	0			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AF11	PB62B	5	PCLKC5_0/BDQ60	C
VCCIO	VCCIO5	5		
GNDIO	GNDIO5	-		
AJ14	PB67A	4	PCLKT4_0/BDQ69	T
VCCIO	VCCIO4	4		
AK14	PB67B	4	PCLKC4_0/BDQ69	C
AK15	PB68A	4	VREF2_4/BDQ69	T
AK16	PB68B	4	VREF1_4/BDQ69	C
AF18	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-		
AD16	PB69B	4	BDQ69	C
AJ15	PB70A	4	BDQ69	T
AG16	PB70B	4	BDQ69	C
AE17	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4		
AC17	PB71B	4	BDQ69	C
AH16	PB72A	4	BDQ69	T
AK17	PB72B	4	BDQ69	C
AG20	PB73A	4	BDQ69	T
GNDIO	GNDIO4	-		
AG21	PB73B	4	BDQ69	C
AG18	PB74A	4	BDQ78	T
AJ16	PB74B	4	BDQ78	C
AF21	PB75A	4	BDQ78	T
AG22	PB75B	4	BDQ78	C
AD17	PB76A	4	BDQ78	T
AF19	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4		
GNDIO	GNDIO4	-		
AH17	PB80A	4	BDQ78	T
AJ17	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4		
AF26	PB82A	4	BDQ78	T
AE25	PB82B	4	BDQ78	C
GNDIO	GNDIO4	-		
AD24	PB92A	4	BDQ96	T
AE24	PB92B	4	BDQ96	C
AD18	PB93A	4	BDQ96	T
AC18	PB93B	4	BDQ96	C
AE18	PB94A	4	BDQ96	T
AG19	PB94B	4	BDQ96	C
VCCIO	VCCIO4	4		
GNDIO	GNDIO4	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AC19	PB96A	4	BDQS96	T
AD20	PB96B	4	BDQ96	C
AB18	PB97A	4	BDQ96	T
AC20	PB97B	4	BDQ96	C
AE20	PB98A	4	BDQ96	T
AE21	PB98B	4	BDQ96	C
VCCIO	VCCIO4	4		
AC23	PB99A	4	BDQ96	T
AD23	PB99B	4	BDQ96	C
GNDIO	GNDIO4	-		
AH18	LRC_SQ_VCCR3	13		
AK19	LRC_SQ_HDINP3	13		T
AJ18	LRC_SQ_VCCIB3	13		
AJ19	LRC_SQ_HDINN3	13		C
AH21	LRC_SQ_VCCTX3	13		
AK22	LRC_SQ_HDOUTP3	13		T
AK21	LRC_SQ_VCCOB3	13		
AJ22	LRC_SQ_HDOUTN3	13		C
AH22	LRC_SQ_VCCTX2	13		
AJ23	LRC_SQ_HDOUTN2	13		C
AH23	LRC_SQ_VCCOB2	13		
AK23	LRC_SQ_HDOUTP2	13		T
AH19	LRC_SQ_VCCR2	13		
AJ20	LRC_SQ_HDINN2	13		C
AH20	LRC_SQ_VCCIB2	13		
AK20	LRC_SQ_HDINP2	13		T
AH24	LRC_SQ_VCCP	13		
AG24	LRC_SQ_REFCLKP	13		T
AF24	LRC_SQ_REFCLKN	13		C
AJ24	LRC_SQ_VCCAUX33	13		
AK28	LRC_SQ_HDINP1	13		T
AH28	LRC_SQ_VCCIB1	13		
AJ28	LRC_SQ_HDINN1	13		C
AH29	LRC_SQ_VCCR1	13		
AK25	LRC_SQ_HDOUTP1	13		T
AH25	LRC_SQ_VCCOB1	13		
AJ25	LRC_SQ_HDOUTN1	13		C
AH26	LRC_SQ_VCCTX1	13		
AJ26	LRC_SQ_HDOUTN0	13		C
AK27	LRC_SQ_VCCOB0	13		
AK26	LRC_SQ_HDOUTP0	13		T
AH27	LRC_SQ_VCCTX0	13		
AJ29	LRC_SQ_HDINN0	13		C

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AF1	PL78B	6	LDQ82	C (LVDS)*	PL95B	6	LDQ99	C (LVDS)*
AE5	PL79A	6	LDQ82	T	PL96A	6	LDQ99	T
AE6	PL79B	6	LDQ82	C	PL96B	6	LDQ99	C
AF4	PL80A	6	LDQ82	T (LVDS)*	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
AF3	PL80B	6	LDQ82	C (LVDS)*	PL97B	6	LDQ99	C (LVDS)*
AF5	PL81A	6	LDQ82	T	PL98A	6	LDQ99	T
AF6	PL81B	6	LDQ82	C	PL98B	6	LDQ99	C
AG1	PL82A	6	LLM0_GPLLT_IN_A**/LDQS82	T (LVDS)*	PL99A	6	LLM0_GPLLT_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
AG2	PL82B	6	LLM0_GPLLC_IN_A**/LDQ82	C (LVDS)*	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AE9	PL83A	6	LLM0_GPLLT_FB_A/LDQ82	T	PL100A	6	LLM0_GPLLT_FB_A/LDQ99	T
AF7	PL83B	6	LLM0_GPLLC_FB_A/LDQ82	C	PL100B	6	LLM0_GPLLC_FB_A/LDQ99	C
VCCIO	VCCIO6	6			VCCIO6	6		
AH1	PL84A	6	LLM0_GDLLT_IN_A**/LDQ82	T (LVDS)*	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AH2	PL84B	6	LLM0_GDLLC_IN_A**/LDQ82	C (LVDS)*	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AG5	PL85A	6	LLM0_GDLLT_FB_A/LDQ82	T	PL102A	6	LLM0_GDLLT_FB_A/LDQ99	T
AG4	PL85B	6	LLM0_GDLLC_FB_A/LDQ82	C	PL102B	6	LLM0_GDLLC_FB_A/LDQ99	C
GNDIO	GNDIO6	-			GNDIO6	-		
AG6	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
AJ1	PL87A	6		T	PL104A	6		T
AJ2	PL87B	6		C	PL104B	6		C
AK2	TCK	-			TCK	-		
AK1	TDI	-			TDI	-		
AL1	TMS	-			TMS	-		
AF10	TDO	-			TDO	-		
AK3	VCCJ	-			VCCJ	-		
AN2	LLC_SQ_VCCRX3	14			LLC_SQ_VCCRX3	14		
AM2	LLC_SQ_HDINP3	14		T	LLC_SQ_HDINP3	14		T
AN1	LLC_SQ_VCCIB3	14			LLC_SQ_VCCIB3	14		
AM3	LLC_SQ_HDINN3	14		C	LLC_SQ_HDINN3	14		C
AN3	LLC_SQ_VCCTX3	14			LLC_SQ_VCCTX3	14		
AP2	LLC_SQ_HDOUTP3	14		T	LLC_SQ_HDOUTP3	14		T
AM1	LLC_SQ_VCCOB3	14			LLC_SQ_VCCOB3	14		
AP3	LLC_SQ_HDOUTN3	14		C	LLC_SQ_HDOUTN3	14		C
AN4	LLC_SQ_VCCTX2	14			LLC_SQ_VCCTX2	14		
AP4	LLC_SQ_HDOUTN2	14		C	LLC_SQ_HDOUTN2	14		C
AL3	LLC_SQ_VCCOB2	14			LLC_SQ_VCCOB2	14		
AP5	LLC_SQ_HDOUTP2	14		T	LLC_SQ_HDOUTP2	14		T
AN5	LLC_SQ_VCCRX2	14			LLC_SQ_VCCRX2	14		
AM4	LLC_SQ_HDINN2	14		C	LLC_SQ_HDINN2	14		C
AL4	LLC_SQ_VCCIB2	14			LLC_SQ_VCCIB2	14		
AM5	LLC_SQ_HDINP2	14		T	LLC_SQ_HDINP2	14		T
AL6	LLC_SQ_VCCP	14			LLC_SQ_VCCP	14		
AL5	LLC_SQ_REFCLKP	14		T	LLC_SQ_REFCLKP	14		T
AK5	LLC_SQ_REFCLKN	14		C	LLC_SQ_REFCLKN	14		C
AK6	LLC_SQ_VCCAUX33	14			LLC_SQ_VCCAUX33	14		
AM6	LLC_SQ_HDINP1	14		T	LLC_SQ_HDINP1	14		T

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2-35E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2-35E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2-35E-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2-35E-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2-35E-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2-50E-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2-50E-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	COM	50
LFE2-50E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2-50E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2-50E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	50

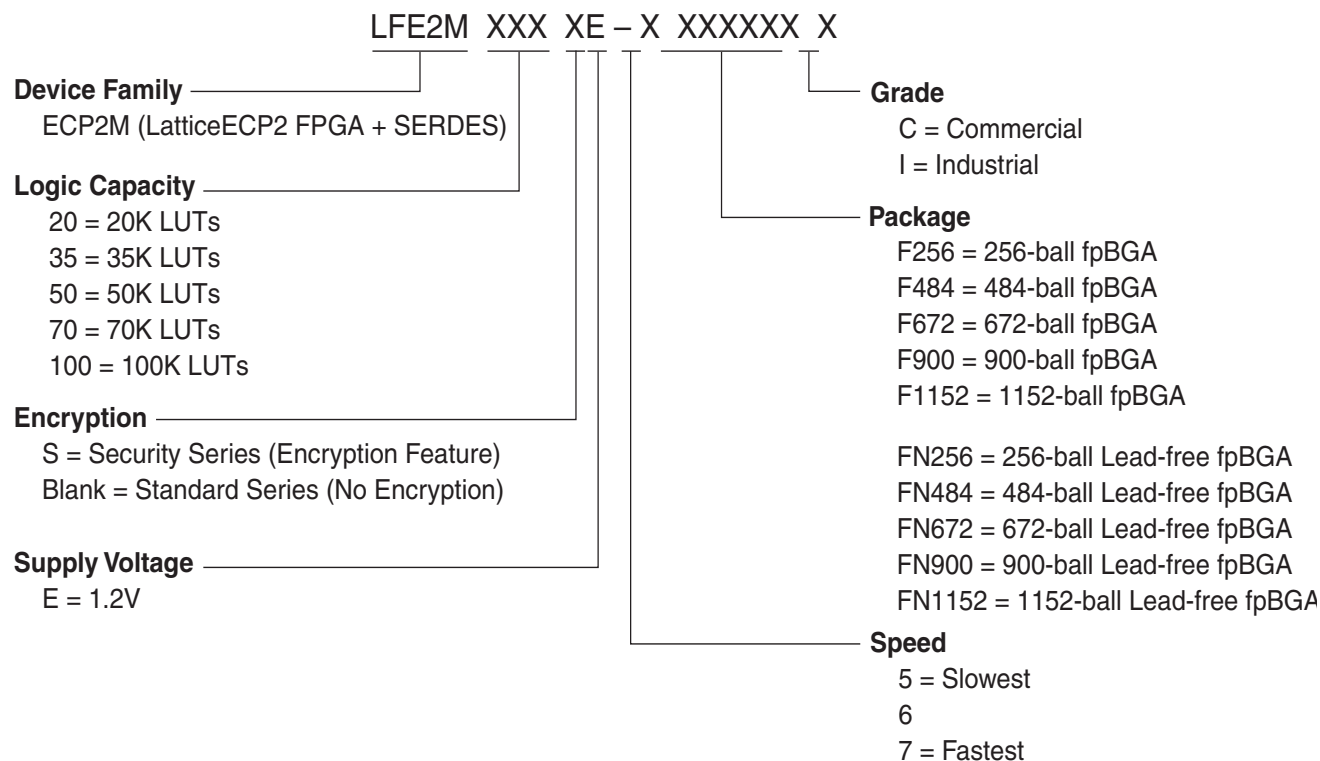
Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	70
LFE2-70E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	70
LFE2-70E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	70
LFE2-70E-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2-70E-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2-70E-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	IND	6
LFE2-6E-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	IND	6
LFE2-6E-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	IND	6
LFE2-6E-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	IND	6

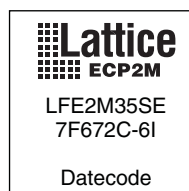
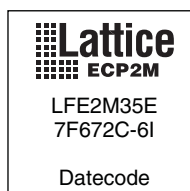
Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	IND	12
LFE2-12E-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	IND	12
LFE2-12E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	12
LFE2-12E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	12
LFE2-12E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	12
LFE2-12E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	12
LFE2-12E-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	IND	12
LFE2-12E-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	IND	12

LatticeECP2M Part Number Description



Ordering Information

Note: LatticeECP2M devices are dual marked. For example, the commercial speed grade LFE2M50E-7F672C is also marked with industrial grade -6I (LFE2M50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial grade does not have industrial markings. The markings appear as follows:



LatticeECP2M Standard Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2M20E-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2M20E-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2M20E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2M20E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2M20E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2M35E-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2M35E-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	COM	35
LFE2M35E-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2M35E-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2M35E-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2M35E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	35
LFE2M35E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	35
LFE2M35E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	COM	50
LFE2M50E-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	COM	50
LFE2M50E-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	COM	50
LFE2M50E-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2M50E-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2M50E-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	COM	50
LFE2M50E-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2M50E-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2M50E-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	COM	70
LFE2M70E-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	COM	70
LFE2M70E-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	COM	70
LFE2M70E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2M70E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2M70E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	70

Date	Version	Section	Change Summary
June 2013 (cont.)	04.0 (cont.)	DC and Switching Characteristics	sysCLOCK SPLL Timing table – Corrected signal names for t_{RST} parameter.
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added t_{SUMCDI} and t_{HMCDI} parameters.
September 2013	04.1	Architecture	Updated Selectable Master Clock (CCLK) Frequencies during Configuration table.
		DC and Switching Characteristics	Added information on f_{MAXSPI} parameter in LatticeECP2/M sys-CONFIG Port Timing Specifications table.